


PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.		MDG/22/13070
1.3 Title of PCI		Enhanced traceability harmonization for listed assembly sites & for all listed products
1.4 Product Category		All listed products
1.5 Issue date		2022-09-28

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	KRAUSE INA
2.1.2 Phone	+49 89460062370
2.1.3 Email	ina.krause@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Ricardo Antonio DE SA EARP
2.1.2 Marketing Manager	Veronique BARLATIER
2.1.3 Quality Manager	Pascal NARCHE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Methods	Traceability (marking content, company logo, etc...)	ST Shenzhen (China) STATSChipPAC SCCJ (China) STATSChipPAC (Singapore) ASE KaoHsiung (Taiwan) AMKOR ATP (The Philippines) AMKOR ATT1 (Taiwan) AMKOR ATT5 (Taiwan) ST Muar (Malaysia)

4. Description of change

	Old	New
4.1 Description	marking composition with no SS marking	marking composition - with no SS marking for current production assembly with old marking composition - with additional SS marking for production assembly with new marking composition
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	Form: Change is visible on marking area Fit : No change Function : No change Reliability : No change Processability : No change	

5. Reason / motivation for change

5.1 Motivation	to enhance traceability
5.2 Customer Benefit	SERVICE IMPROVEMENT

6. Marking of parts / traceability of change

6.1 Description	traceability ensured by ST internal tools
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7. Timing / schedule

7.1 Date of qualification results	2022-09-23
7.2 Intended start of delivery	2022-11-01
7.3 Qualification sample available?	Not Applicable

8. Qualification / Validation			
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8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

9. Attachments (additional documentations)			
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13070 Public product.pdf 13070 PCI13070_Additional information.pdf

10. Affected parts		
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10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STM32F031F4P7	
	STM32F042F6P7	
	STM32F070F6P6TR	
	STM32L011F3P6TR	
	STM32L011F4P6TR	
	STM32L041F6P7	
	STM32L476JEY6TR	
	STM32L496VGY6TR	
	STM32G050F6P6	
	STM32G061F6P6	
2980912	STM32G071RBI6	
3132387	STM32G431RBI6	
2980939	STM32L422RBI6	
2855696	STM32L433RBI6	
	STM32L443RCI6	
2758808	STM32L452REI6	
2851029	STM32L496VGY6PTR	
	STM32L4A6VGY6PTR	
3515806	STM32WB55VGY6TR	

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